

**Application Data Sheet****Applicant Information**

Applicant Authority type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Naoto
Family Name::	NAKAMURA
City of Residence::	Tokyo
Country of Residence::	JAPAN

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Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Iwao
Family Name::	NAKAMURA
City of Residence::	Tokyo
Country of Residence::	JAPAN

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Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Tomoharu
Family Name::	SHIMADA
City of Residence::	Tokyo
Country of Residence::	JAPAN

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Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Kenichi
Family Name::	ISHIGURO
City of Residence::	Tokyo
Country of Residence::	JAPAN

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Applicant Authority Type:: Inventor  
Primary Citizenship Country:: Japan  
Status:: Full Capacity  
Given Name:: Sadao  
Family Name:: NAKASHIMA  
City of Residence:: Tokyo  
Country of Residence:: JAPAN

**Correspondence Information**

Correspondence Customer Number:: 25944

**Application Information**

Application Type:: National Phase  
Subject Matter:: Utility  
CD-ROM or CD-R:: None  
Title:: THERMAL TREATMENT APPARATUS,  
METHOD FOR MANUFACTURING  
SEMICONDUCTOR DEVICE, AND  
METHOD FOR MANUFACTURING  
SUBSTRATE  
  
Attorney Docket Number:: 122733  
Total Drawing Sheets:: 11  
Small Entity:: No

**Representative Information**

Domestic Priority Information			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP03/012353	09/26/03

<b>Foreign Priority Information</b>			
Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2002-282231	09/27/02	Yes
Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2003-051243	02/27/03	Yes
Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2003-051244	02/27/03	Yes
<b>Assignee Information</b>			
Assignee Name::		HITACHI KOKUSAI ELECTRIC INC.	
Street of mailing address::		14-20, 3-chome, Higashi-Nakano,	
		Nakano-Ku	
City of mailing address::		Tokyo	
Country of mailing address::		JAPAN	
Postal or Zip Code of mailing address::		164-8511	